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## In the Claims:

## Please have the Claims depicted as follows for purposes of Appeal:

- 1. (Withdrawn) A radiation curable hot melt composition that can be cured by radiation only to a non-tacky coating, said composition comprising:
- a) 20 to 100 wt.% of a radiation curable resin or a mixture of radiation curable resins having a viscosity in the range from 15 to 10,000 mPas in the temperature range from 40 to 150°C,
- b) 0 to 50 wt.% of a hydroxyfunctional resin or oligomer or a mixture of hydroxyfunctional resins or oligomers,
- c) 0 to 10 wt.% of a photoinitiator,
- d) 0 to 50 wt.% of fillers and/or additives, and
- e) 0 to 40 wt.% of pigment,
- wherein the total amount of components a) to e) adds up to 100 wt.%.
- 2. (Withdrawn) The radiation curable hot melt composition of claim 1, wherein the radiation curable resin or the mixture of radiation curable resins has a  $T_{\alpha}$  below 0°C.
- 3. (Withdrawn) The radiation curable hot melt composition of claim 1, wherein the composition is a coating composition comprising a radiation curable resin or a mixture of radiation curable resins with a viscosity in the range from 15 to 4,000 mPas in the temperature range from 40 to 150°C.
- 4. (Withdrawn) The radiation curable hot melt composition of claim 1, wherein the composition is a putty composition comprising a radiation curable resin or a mixture of radiation

curable resins with a viscosity in the range from 3,000 to 10,000 mPas in the temperature range from 40 to 150°C.

- The radiation curable hot melt composition 5. (Withdrawn) according to claim 1, wherein the composition comprises a polyesteracrylate resin.
- 6. (Previously Presented) A process for coating a substrate to provide a non tacky protective coating or film thereon, said process comprising the steps of:
  - i) providing a radiation curable hot melt composition comprising a) 20 to 100 wt.% of a radiation curable resin or a mixture of radiation curable resins having a viscosity in the range from 15 to 10,000 mPas in the temperature range from 40 to 150°C, b) 0 to 50 wt.% of a hydroxyfunctional resin or oligomer or a mixture of hydroxyfunctional resins or oligomers, c) 0 to 10 wt. % of a photoinitiator, d) 0 to 50 wt.% of fillers and/or additives, and e) 0 to 40 wt.% of pigment, wherein the total amount of components a) to e) adds up to 100 wt.%,
  - heating said hot melt composition to a temperature in the ii) range from 40 to 150°C,
  - iii) applying said hot melt composition to the substrate in the form of a coating or thin film, and
  - iv) curing said hot melt to a non-tacky coating solely by exposing the coated substrate to electromagnetic radiation having a wavelength  $\lambda \leq 500$  nm.
  - 7. (Original) The process according to claim 6, wherein the substrate is a heat-sensitive substrate.

- 8. (Original) The process according to claim 7, wherein the substrate contains cellulose and/or plastic and the hot melt composition is heated to a temperature in the range from 40 to 100°C.
- 9. (Original) The process according to claim 6, wherein the hot melt composition comprises a resin or a mixture of resins with a  $T_{\alpha}$  below 0°C.
- 10. (Original) The process according to claim 6, wherein the hot melt composition comprises a polyesteracrylate resin.
- 11. (Previously Presented) A process for coating a substrate to provide a non tacky protective coating or film thereon, said process comprising the steps of:
  - [iii)] i) providing a radiation curable hot melt composition comprising a) 20 to 100 wt.% of a radiation curable resin or a mixture of radiation curable resins having a viscosity in the range from 15 to 10,000 mPas in the temperature range from 40 to 150°C, b) 0 to 50 wt.% of a hydroxyfunctional resin or oligomer or a mixture of hydroxyfunctional resins or oligomers, c) 0 to 10 wt.% of a photoinitiator, d) 0 to 50 wt.% of fillers and/or additives, and e) 0 to 40 wt.% of pigment, wherein the total amount of components a) to e) adds up to 100 wt.%,
  - [iv)] <u>ii)</u> heating said hot melt composition to an application temperature in the range from 40 to  $90^{\circ}$ C,
- iii) applying said hot melt composition to the substrate in the form of a coating or thin film, and
  - [v)] <u>iv)</u> curing said hot melt by exposing the coated substrate to electromagnetic radiation having a wavelength  $\lambda \leq 500$  nm.

- 12. (Currently Amended) The process according to claim [6] 11 , wherein the substrate is a heat-sensitive substrate.
  - 13. (Currently Amended) The process according to claim [7] 12, wherein the substrate contains cellulose and/or plastic and the hot melt composition is heated to a temperature in the range from 40 to 100°C.
    - 14. (Currently Amended) The process according to claim [6] 11, wherein the hot melt composition comprises a resin or a mixture of resins with a T<sub>q</sub> below 0°C.
  - (Currently Amended) The process according to claim [6] 11, wherein the hot melt composition comprises a polyesteracrylate resin.
  - 16. (Previously Presented) A process for coating a substrate to provide a non tacky protective coating or film thereon, said process comprising the steps of:
    - [v)] i) providing a radiation curable hot melt composition comprising a) 40 to 90 wt.% of an ultraviolet radiation curable polyester acrylate resin having a viscosity in the range from 15 to 10,000 mPas in the temperature range from 40 to 150°C, b) 0 to 50 wt.% of a hydroxyfunctional resin or oligomer or a mixture of hydroxyfunctional resins or oligomers, c) 0 to 10 wt.% of a photoinitiator, d) 0 to 50 wt.% of fillers and/or additives, and e) 0 to 40 wt.% of pigment, wherein the total amount of components a) to e) adds up to 100 wt. %,
    - [vi)] ii) heating said hot melt composition to a temperature in the range from 40 to 150°C,

- iii) applying said hot melt composition to the substrate in the form of a coating or thin film, and
- [vi)] iv) curing said hot melt to a non-tacky coating solely by exposing the coated substrate to electromagnetic radiation having a wavelength  $\lambda \leq 500$  nm.
- 17. (Previously Presented) The process according to claim 16, wherein the hot melt composition further comprises a UV curable polyurethane acrylate resin and/or a UV curable epoxy acrylate resin.